Intel/Sony Joint EMI Testing on 1394 CE to PC Interconnect

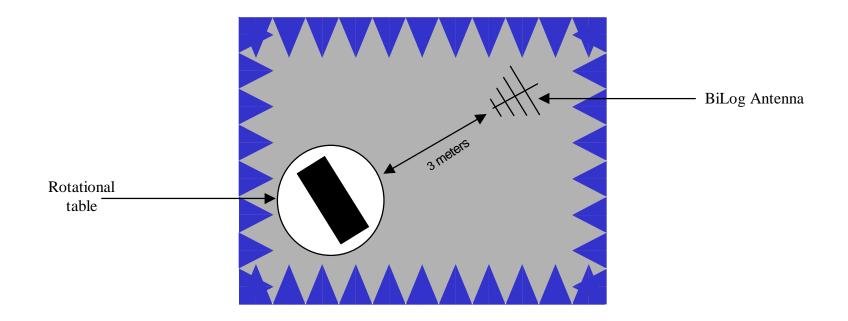
Steven Midford Intel Corporation (Intel Architecture Lab)

Presented to P1394a committee September 25-26, 1997 Natick, Massachusetts

Three Meter Anechoic Chamber

- Room completely shielded from outside radiation
- Carbon Absorber Cones used to absorb radiation produced from Device Under Test (DUT)
- BiLOG antenna used to receive Device Emissions
- Antenna positioned three meters from DUT

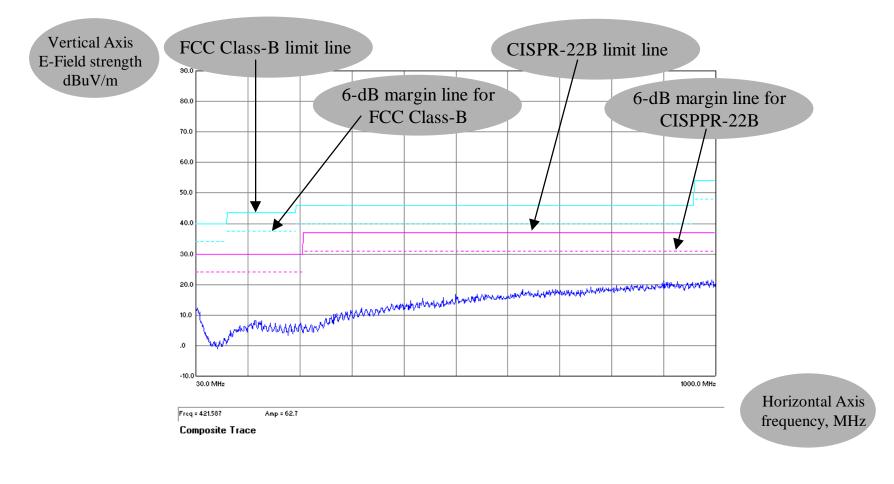
Three Meter Anechoic Chamber Floor Layout



FCC and CISPR-22B Limits

FCC Class B Radiated Limits			CISPR-22 Class B limits		
Frequency (MHz)	Distance (meters)	Field Strength DBuV/m	Frequency (MHz)	Distance (meters)	Field Strength DBuV/m
30 - 88	3	40	30 - 230	10	30 (36)
88 - 216	3	43.52	230 - 1000	10	37 (43)
216 - 960	3	46.02	N/A	N/A	N/A
960 - 2000	3	53.92	N/A	N/A	N/A

Interpreting emissions graph

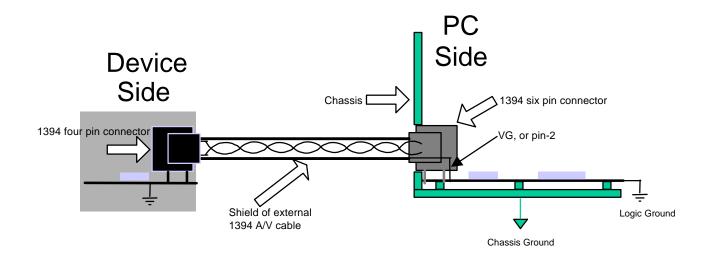


Original 1394 4-to-6 pin A/V cable

- Shield connects to VG (pin-2) of the six pin receptacle; connects to shell of four pin plug
- EMI unfriendly for PCs
 - When attached to a motherboard, radiation close to or above the FCC limit is inevitable

1394 4-to-6 pin A/V cable environment for CE to PC interconnect

Original A/V cable

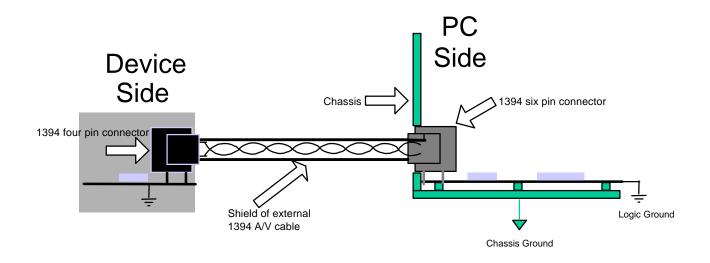


S100-only 1394 4-to-6 pin A/V cable

- Shield connects to shell of both the six and four pin plugs
- Supports only S100 as there is no return path for the common mode speed signal

1394 4-to-6 pin A/V cable environment for CE to PC interconnect

S100-only A/V cable

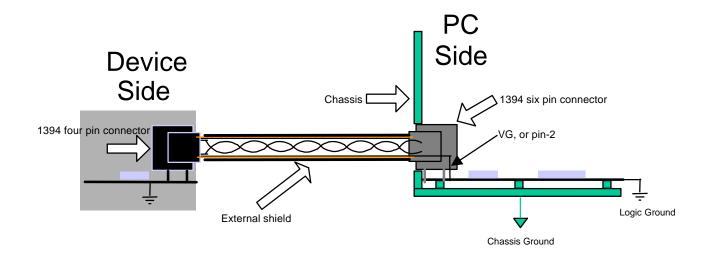


1394A/V cable proposed for S100-S400 $\,$

- Cable construction closely resembles six conductor cable
- Foil shield wrapped around each pair
 - foil shield connects to VG of six-pin receptacle
- Braided shield terminates at shell of six pin plug
 - provides an AC return path for stray currents traveling on the outer surface of the foil shield which results in <u>reduced</u> emissions
- Braided shield is left unterminated at four-pin plug

1394 4-to-6 pin A/V cable environment for CE to PC interconnect

Proposed 1394 A/V cable



Systems Under Test

- 1394-Test Vehicle Platform build by Intel®
 - 1394-1995 Link and PHY chip laid out on mother board
 - PHY/Link DC Coupled both chips share ground plane with the rest of the system
 - Sticky fingers allow for various points of contact between the chassis and the receptacle.
- Sony® Camcorder
 - Incorporates four-pin connector
- Sony[®] Conferencing camera
 - Incorporates six-pin connector

1394 Platform Grounding Scheme

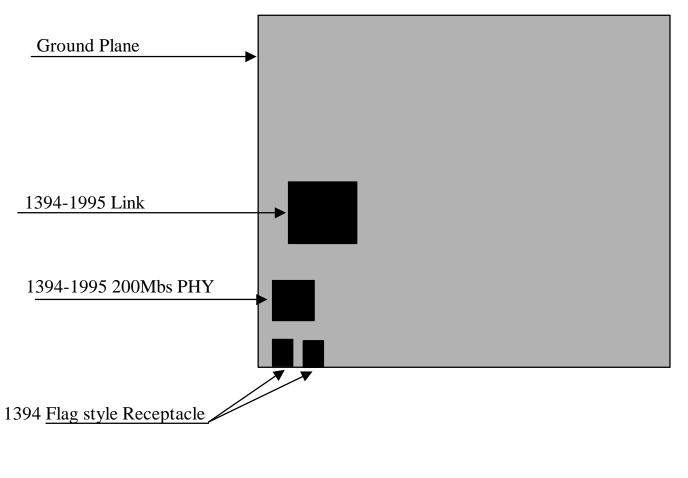
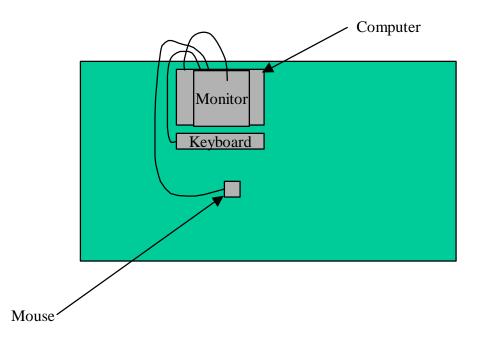
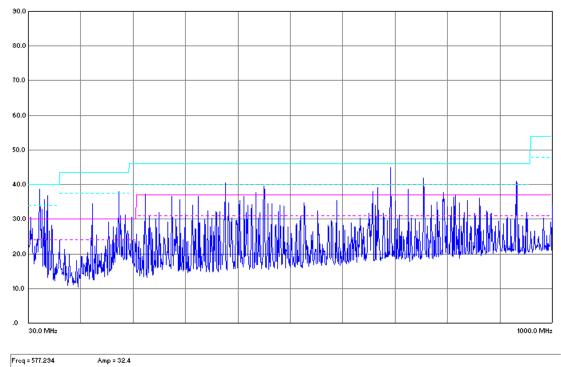


Table Layout for baseline of 1394-System

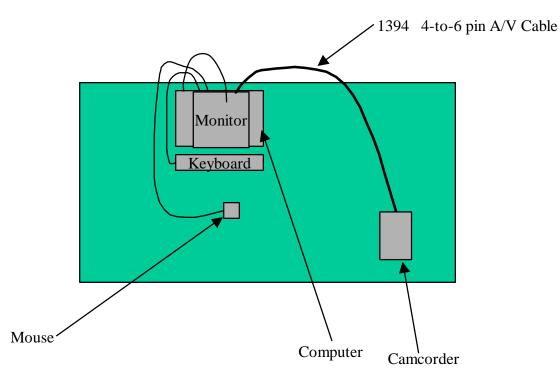


Baseline scan of 1394 platform

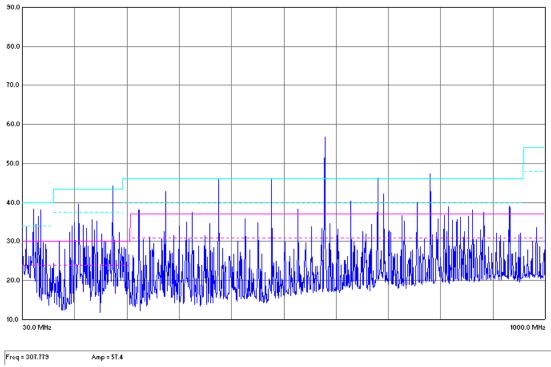


Composite Trace

Table Layout for System plus Camcorder

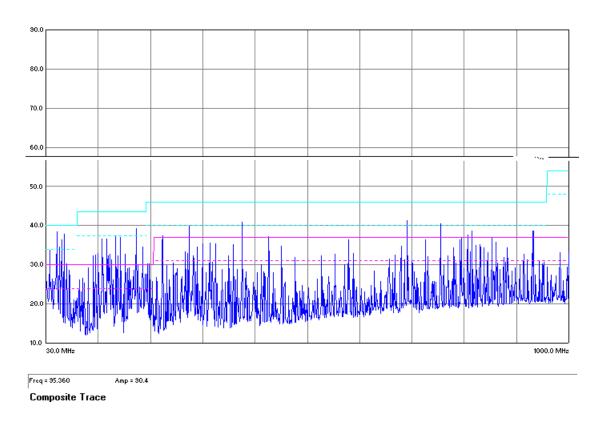


Emissions of 1394-System plus camcorder utilizing original A/V cable





Emissions of 1394-System plus camcorder utilizing S100-only A/V cable



9/16/97

Four to six pin emissions data Document# 97-056R0

18

Emissions of 1394-System plus camcorder utilizing Proposed A/V cable

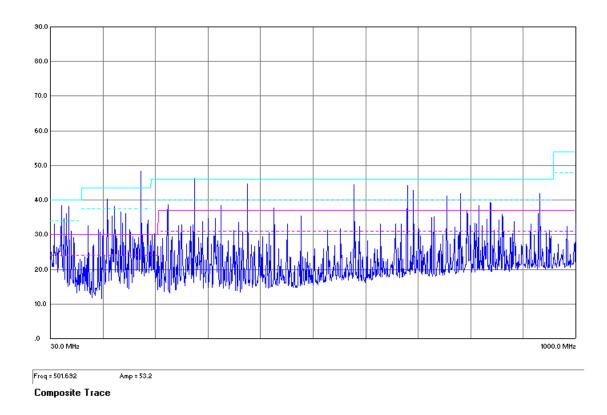
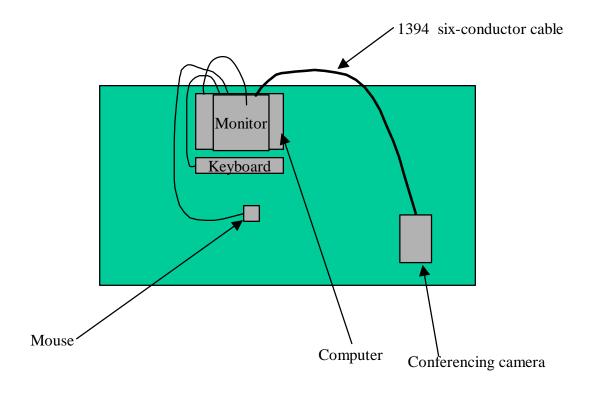
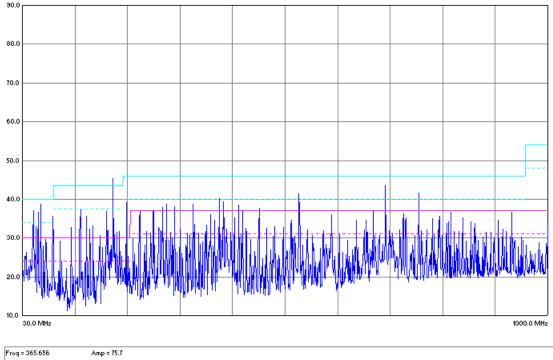


Table Layout for System plus conferencing camera



Emissions of 1394-System plus conferencing camera utilizing sixconductor cable



Composite Trace

The emissions from this configuration shouldn't be considered as a valid comparison with the previous configurations as the conferencing camera introduces a second variable.

Conclusions

- Original A/V cable produces emissions above or at the FCC limit at several frequencies
- There are seven discrete spectral lines that either approach or fail the FCC limit
- These discrete spectral lines are reduced by and average of 3.6 dB when the proposed A/V is used.